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Examiner	Art Unit	
Hiep Nguyen	2816	
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Art Unit: 2816

Reason for allowance

The following is an examiner's statement of reasons for allowance:

The prior art of records fails to teach or fairly suggest a method of assembling a semiconductor package comprising forming a first inductor within the semiconductor package; forming a second inductor within the semiconductor package and in parallel with the first inductor, wherein the first and second inductors are formed within the semiconductor package so that an interfering magnetic signal induces a commonmode signal in the parallel combination of the first and second inductors as called for in claim 22. Therefore, claims 22-39 are presently allowed.

Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Hiep Nguyen whose telephone number is (571) 272-1752. The examiner can normally be reached on Monday to Friday from 7:30am to 4:00pm.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Timothy Callahan can be reached on (571) 272-1740. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Hiep Nguyen

07-01-04

TUANT.LAM
PRIMARY EXAMINER